

L Number	Hits	Search Text	DB	Time stamp
7	74	204/224R.ccls. and distribut\$4 and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:00
13	0	204/275.1.ccls. and distributor and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:01
19	10	204/275.1.ccls. and distributor	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:51
1	202	204/224R.ccls. and distribut\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:23
25	11	204/275.1.ccls. and diffusion adj plate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:37
31	2	5980706.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:39
37	0	5980706.pn. and distributor	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:40
43	1	5980706.pn. and distribut\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:42
49	1	6099712.pn. and distribut\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:44
55	1	6270647.pn. and distribut\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:51
61	5699	204/275.1.ccls. and distributor or diffusion adj plate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:52
67	11	204/275.1.ccls. and diffusion adj plate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 12:52
-	241	204/224R.ccls. and pump	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/12 11:47
-	241	204/224R.ccls. and pump	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/11 16:49